

Very low offset single bipolar operational amplifier

Features

■ Extremely low offset: 150µV/ max.

■ Low input bias current: 1.8nA

■ LOW V_{io} drift: 0.5µV/°C

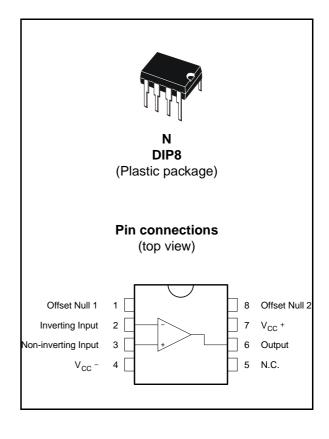
■ Ultra stable with time: 2µV/month max.■ Wide supply voltage range: ±3V to ± 22V

■ Temperature range: 0°C to -105°C

Description

The OP07 is a very high precision op-amp with an offset voltage maximum of $150\mu V$.

Offering also low input current (1.8nA) and high gain (400V/mV), the OP07C is particularly suitable for instrumentation applications.



Schematic diagram OP07

1 Schematic diagram

Figure 1. Schematic diagram

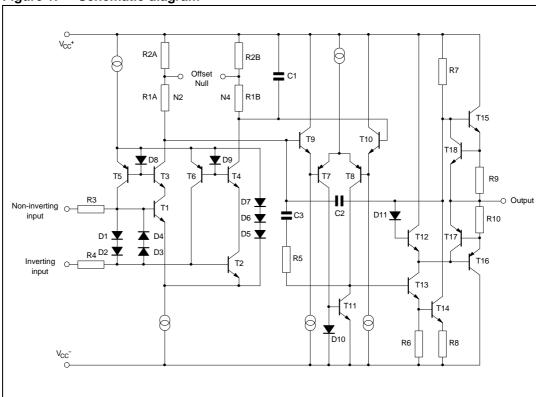
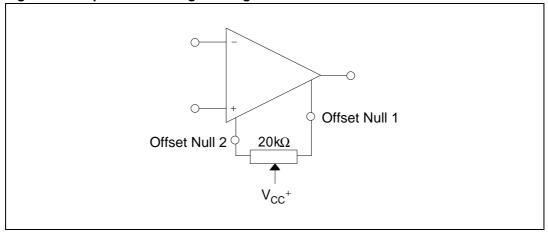


Figure 2. Input offset voltage nulling circuit



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2 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	± 22	V
V _{id}	Differential input voltage	± 30	V
V _i	Input voltage	± 22	V
T _{oper}	Operating temperature	-40 to 105	°C
T _{stg}	Storage temperature	-65 to 150	°C
R _{thja}	Thermal resistance junction to ambient ⁽¹⁾ (2) DIP8	85	°C/W
R _{thjc}	Thermal resistance junction to case ^{(1) (2)} DIP8	41	°C/W
	HBM: human body model ⁽³⁾	1.5	kV
ESD	MM: machine model ⁽⁴⁾	200	V
	CDM: charged device model ⁽⁵⁾	1.5	kV

^{1.} Short-circuits can cause excessive heating and destructive dissipation.

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^{2.} R_{th} are typical values.

Human body model: 100pF discharged through a 1.5kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.

^{4.} Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor $< 5\Omega$). Done for all couples of pin combinations with other pins floating.

Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Electrical characteristics OP07

3 Electrical characteristics

Table 2. $V_{CC}^+ = 15 \text{ V}, V_{CC}^- = \text{Ground}, T_{amb} = 25^{\circ} \text{ C} \text{ (unless otherwise specified)}$

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{io}	Input offset voltage $0^{\circ}C \le T_{amb} \le +105^{\circ}C$		60	150 250	μV
	Long term input offset - voltage stability (1)		0.4	2	μV/Mo
DV _{io}	Input offset voltage drift		0.5	1.8	μV/°C
l _{io}	Input offset current ($V_{ic} = 0V$) $0^{\circ}C \le T_{amb} \le +105^{\circ}C$		0.8	6 7	nA
DI _{io}	Input offset current drift		15	50	pA/°C
DI _{ib}	Input bias current drift		15	50	pA/°C
R _o	Open loop output resistance		60		Ω
R _{id}	Differential input resistance		33		MW
R _{ic}	Common mode input resistance		120		GW
V _{icm}	Input common mode voltage range $0^{\circ}C \le T_{amb} \le +105^{\circ}C$	±13 ±13	±13.5		V
CMR	Common-mode rejection ratio ($V_{ic} = V_{icm - min}$) $0^{\circ}C \le T_{amb} \le +105^{\circ}C$	100 97	120		dB
SVR	Supply voltage rejection ratio ($V_{CC} = \pm 3$ to $\pm 18V$) $0^{\circ}C \le T_{amb} \le \pm 105^{\circ}C$	90 86	104		dB
A _{vd}	Large signal voltage gain $ \begin{array}{l} V_{CC}=\pm 15,\ R_L=2k\Omega,\ V_O=\pm 10V\\ 0^\circ C\le T_{amb}\le +105^\circ C\\ V_{CC}=\pm 3,\ R_L=500\Omega,\ V_O=\pm 0.5V \end{array} $	120 100 100	400 400		V/mV
V _{opp}	Output voltage swing $ \begin{array}{l} R_L = 10k\Omega \\ R_L = 2k\Omega \\ R_L = 1k\Omega \\ 0^\circ C \le T_{amb} \le +105^\circ C \ R_L = 2k\Omega \end{array} $	±12 ±11.5	±13 ±12.8 ±12		V
SR	Slew rate ($R_L = 2k\Omega$, $C_L = 100pF$)		0.17		V/µs
GBP	Gain bandwidth product ($R_L = 2k\Omega$, $C_L = 100pF$, $f = 100kHz$)		0.5		MHz
I _{CC}	Supply current - no load $0^{\circ}C \le T_{amb} \le +105^{\circ}C$ $V_{CC} = \pm 3V$		2.7 0.67	5 6 1.3	mA

OP07 Package information

Table 2. $V_{CC}^+ = 15 \text{ V}, V_{CC}^- = \text{Ground}, T_{amb} = 25^{\circ} \text{ C} \text{ (unless otherwise specified) (continued)}$

Symbol	Parameter	Min.	Тур.	Max.	Unit
e _n	Equivalent input noise voltage f = 10Hz f = 100Hz f = 1kHz		11 10.5 10	20 13.5 11.5	<u>nV</u> √Hz
i _n	Equivalent input noise current f = 10Hz f = 100Hz f = 1kHz		0.3 0.2 0.1	0.9 0.3 0.2	<u>pA</u> √Hz

Long term input offset voltage stability refers to the average trend line of Vio vs time over extended periods after the first 30 days of operation.

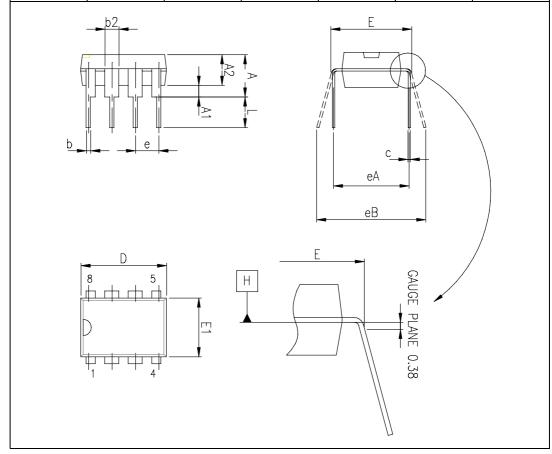
4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Package information OP07

Figure 3. DIP8 package mechanical data

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.045	0.060	0.070
С	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	10.16	0.355	0.365	0.400
E	7.62	7.87	8.26	0.300	0.310	0.325
E1	6.10	6.35	7.11	0.240	0.250	0.280
е		2.54			0.100	
eA		7.62			0.300	
eB			10.92			0.430
L	2.92	3.30	3.81	0.115	0.130	0.150



5 Ordering information

Table 3. Order codes

Part number	Temperature range	Package	Packing	Marking
OP07C OP07CN	0°C, +105°C	DIP8	Tube	OP07CN

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
20-May-2003	1	Initial release.
23-Jul-2007	2	Format update. R _{thja} , R _{thjc} , and ESD values added in <i>Table 1: Absolute maximum ratings</i> . Temperature range modified to 0-105°C.

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